

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE01P18L uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

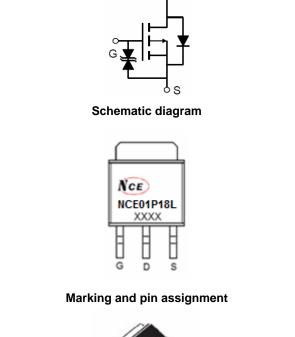
- V_{DS} =-100V,I_D =-18A
 R_{DS(ON)} <100mΩ @ V_{GS}=-10V (Typ:85mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

- Power management in notebook computer
- Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



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TO-251S top view

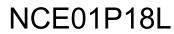
Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P18L	NCE01P18L	TO-251S	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	-18	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-12	A
Pulsed Drain Current	I _{DM}	-72	A
Maximum Power Dissipation	PD	70	W
Derating factor		0.56	W/°C
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	$R_{ extsf{ heta}Jc}$	1.79	°C /W
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·	•	•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±20	μA
On Characteristics (Note 3)	·	•	•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.9	-3	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-16A	-	85	100	mΩ
Forward Transconductance	g fs	V _{DS} =-50V,I _D =-10A	5	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	2100	-	PF
Output Capacitance	C _{oss}	V_{DS} =-25V, V_{GS} =0V,	-	590	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	140	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	16	-	nS
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-16A	-	73	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =9.1Ω	-	34	-	nS
Turn-Off Fall Time	t _f		-	57	-	nS
Total Gate Charge	Qg)/ 00)// 40A	-	61	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-80V,I _D =-16A,	-	14	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	29	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-18A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	-18	A
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-18A	-	88.3	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	65.9	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ\!\mathrm{C}$,V_DD=-50V,V_G=-10V,L=0.5mH,Rg=25 Ω

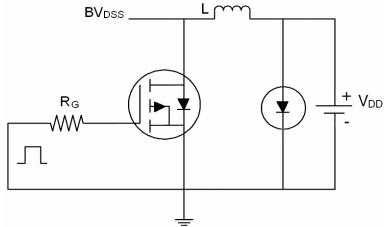


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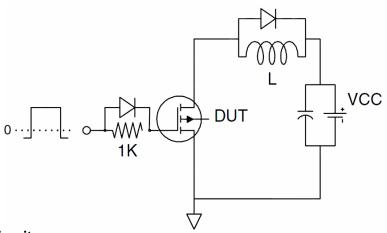




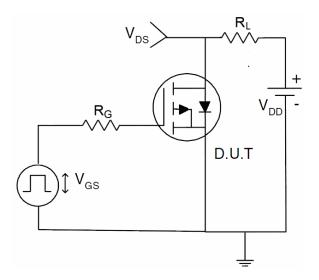
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



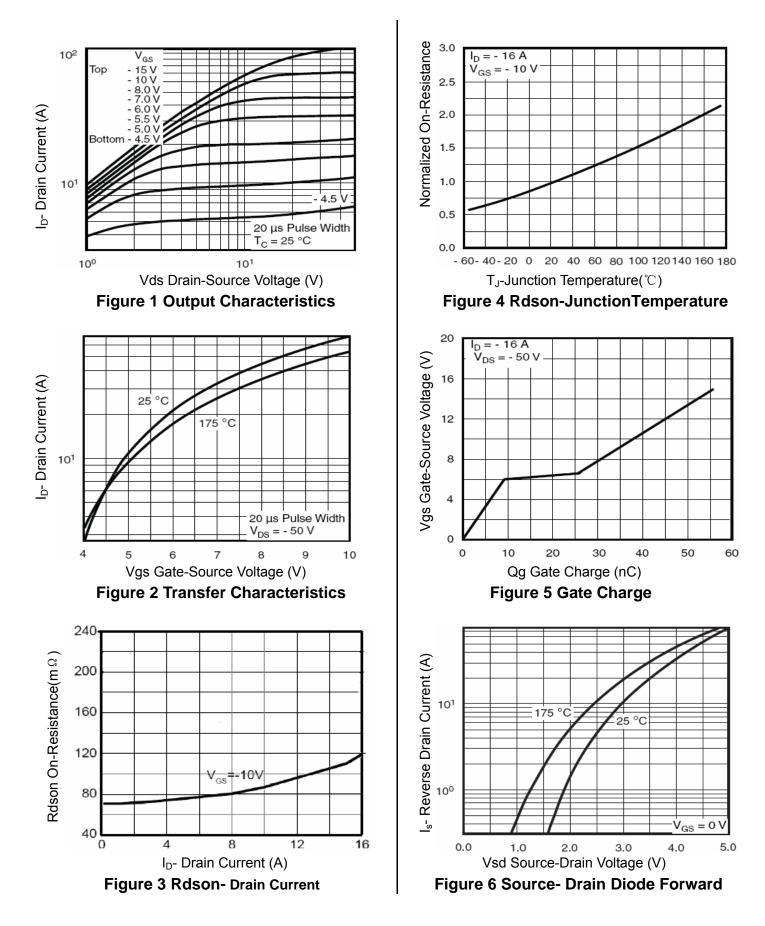
3) Switch Time Test Circuit







Typical Electrical and Thermal Characteristics (Curves)





C Capacitance (nF)

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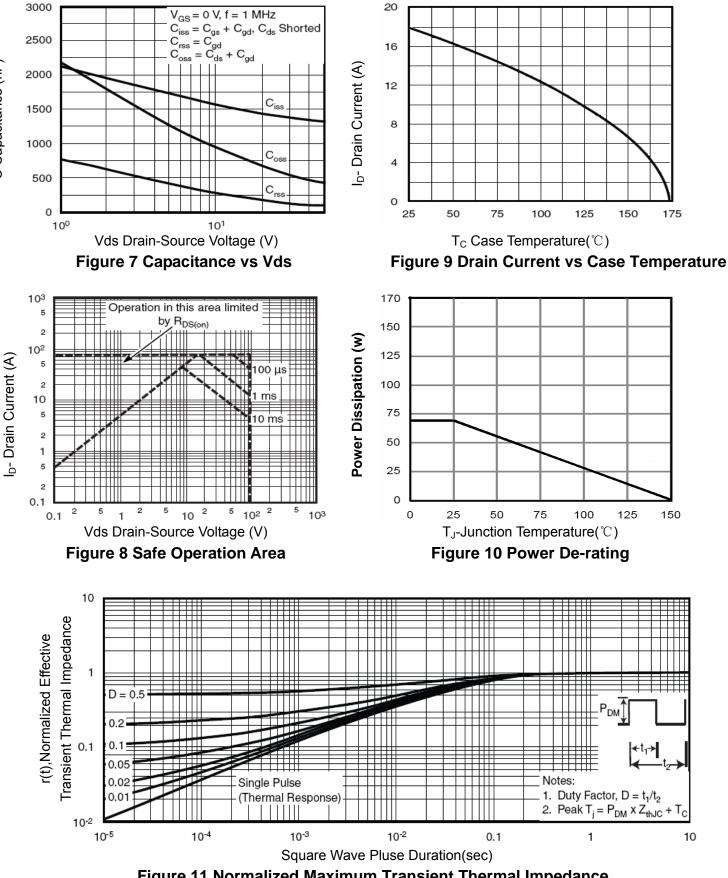


Figure 11 Normalized Maximum Transient Thermal Impedance

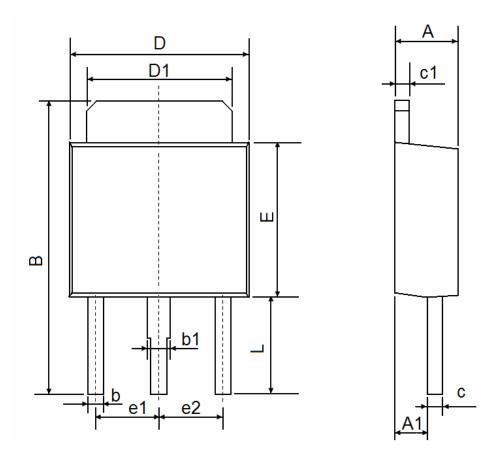
Pb Free Product

NCE01P18L





TO-251S Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.250	2.350	0.089	0.093	
A1	1.150	1.250	0.045	0.049	
В	10.200	10.800	0.402	0.425	
b	0.550	0.650	0.022	0.026	
b1	0.750	0.850	0.030	0.033	
С	0.480	0.540	0.019	0.021	
c1	0.480	0.540	0.019	0.021	
D	6.400	6.600	0.252	0.260	
D1	5.250	5.350	0.207	0.211	
E	5.400	5.600	0.213	0.220	
e1	2.300 TYP		0.091 TYP		
e2	2.300 TYP		0.091 TYP		
L	3.300	3.700	0.130	0.146	







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